

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants: Syouji NOGAMI et al.

**Confirmation No. 8539**

Serial No.: 10/562,235

Group Art Unit: 2813

Filed : October 31, 2006

Examiner: Sonya D. McCall Shepard

**For: MANUFACTURING METHOD OF SEMICONDUCTOR WAFER AND  
SEMICONDUCTOR WAFER MANUFACTURED BY THIS METHOD**

United States Patent and Trademark Office  
Customer Service Window, Mail Stop Amendment  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314

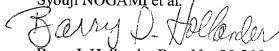
**REQUEST FOR EXTENSION OF TIME**

Sir:

Please extend the time for response to the Official Action dated July 17, 2009 by one month from October 17, 2009 to November 17, 2009. The amount of \$130.00 is submitted concurrently herewith as payment for the fee.

The U.S. Patent and Trademark Office is hereby authorized to credit any overpayment or charge any additional fee to Deposit Account No.19-0089.

Respectfully submitted,  
Syouji NOGAMI et al.



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November 17, 2009  
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